

<b>REISSUE APPLICATION DECLARATION BY THE ASSIGNEE</b>		Docket Number (optional) DENSE-015X
I hereby declare that: My residence and post office address and citizenship are stated below next to my name. I am authorized to act on behalf of the following assignee: <u>DENSE-PAC MICROSYSTEMS, INC.</u> and the title of my position with said assignee is: <u>PRESIDENT</u> The entire title to the patent identified below is vested in said assignee.		
Name of Patentee(s): <u>AARON URI LEVY, ET AL.</u>		
Patent Number <u>5,869,353</u>	Date of Patent Issued <u>02/09/99</u>	
Title of Invention <u>MODULAR PANEL STACKING PROCESS</u>		
I believe said patentee(s) to be the original, first and sole/joint inventor(s) of the subject matter which is described and claimed in said patent, for which a reissue patent is sought on the invention entitled <u>MODULAR PANEL STACKING PROCESS</u> the specification of which <input checked="" type="checkbox"/> is attached hereto. <input type="checkbox"/> was filed on _____ as reissue application number _____ / _____ and was amended on _____ (If applicable) I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR 1.56. I verily believe the original patent to be wholly or partly inoperative or invalid, for the reasons described below. (Check all boxes that apply.) <input type="checkbox"/> by reason of a defective specification or drawing. <input checked="" type="checkbox"/> by reason of the patentee claiming more or less than he had the right to claim in the patent. <input type="checkbox"/> by reason of other errors. At least one error upon which reissue is based is described as follows: Since no apparatus claims were prosecuted in U.S. Application Serial No. 08/971,499 (the "499 Application") which matured into the '353 Patent, Applicant respectfully submits that it is not barred from seeking the issuance of apparatus claims via the present reissue patent application. [Attach additional sheets, if needed.] All errors corrected in this reissue application arose without any deceptive intention on the part of the applicant.		

(REISSUE APPLICATION DECLARATION BY THE ASSIGNEE, page 2)		Docket Number (Optional ) DENSE-015X	
I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.			
Name(s)		Registration Number	
KIT M. STETINA		29,445	
MARK B. GARRED		34,823	
Correspondence Address: Direct all communications about the application to:			
<input checked="" type="checkbox"/> Customer Number		007663	
OR		Type Customer Number Here	
<input type="checkbox"/> Firm or Individual Name		Place Customer Number Bar Code Label Here	
Address			
Address			
City		State	Zip
Country			
Telephone		Fax	
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine and imprisonment, or both, under 18 U.S.C. 1001, and that such willful false statements may jeopardize the validity of the application, any patent issuing thereon, or any patent to which this declaration is directed.			
Full name of person signing (given name, family name) TED BRUCE, PRESIDENT OF DENSE-PAC MICROSYSTEMS, INC.			
Signature <i>Ted Bruce</i>		Date 7/28/00	
Address of Assignee 7321 LINCOLN WAY, GARDEN GROVE, CA 92841			
Patentee AARON URI LEVY, ET AL.		Citizenship U.S.	
Residence/Post Office Address 7108 KATELLA AVE., #413, STANTON, CA 90680			
Patentee		Citizenship	
Residence/Post Office Address			

**REISSUE APPLICATION BY THE ASSIGNEE,  
OFFER TO SURRENDER PATENT**

Docket Number (Optional)

DENSE-015X

This is part of the application for a reissue patent based on the original patent identified below.

Name of Patentee(s):

AARON URI LEVY, ET AL.

Patent Number

5,869,353

Date Patent Issued

02/09/99

Title of Invention

MODULAR PANEL STACKING PROCESS

DENSE-PAC

MICROSYSTEMS, INC.

is the assignee of the entire interest in the original patent.

I offer to surrender the original patent.



A certificate under 37 CFR 3.73(b) is attached.

I am authorized to act on behalf of the assignee.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. 1001 and that such willful false statements may jeopardize the validity of the application, any patent issued thereon, or any patent to which this declaration is directed.

Name of assignee

DENSE-PAC MICROSYSTEMS, INC.

Signature of person signing for assignee

Date 7/28/00

Typed or printed name and title of person signing for assignee

TED BRUCE, PRESIDENT

Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it displays a valid OMB control number.

**STATEMENT UNDER 37 CFR 3.73(b)**

Applicant/Patent Owner: DENSE-PAC MICROSYSTEMS, INC.

Application No./Patent No.: 5,869,353 Filed/Issue Date: 02/09/99

Entitled: MODULAR PANEL STACKING PROCESS

DENSE-PAC MICROSYSTEMS, INC., a California corporation

(Name of Assignee)

(Type of Assignee, e.g., corporation, partnership, university, government agency, etc.)

states that it is:

1. ☒ the assignee of the entire right, title, and interest; or

2. ☐ an assignee of an undivided part interest

in the patent application/patent identified above by virtue of either:

A. ☒ An assignment from the inventor(s) of the patent application/patent identified above. The assignment was recorded in the Patent and Trademark Office at Reel 8832, Frame 0596, or for which a copy thereof is attached.

OR

B. ☐ A chain of title from the inventor(s), of the patent application/patent identified above, to the current assignee as shown below:

1. From: \_\_\_\_\_ To: \_\_\_\_\_  
The document was recorded in the Patent and Trademark Office at  
Reel \_\_\_\_\_, Frame \_\_\_\_\_, or for which a copy thereof is attached.

2. From: \_\_\_\_\_ To: \_\_\_\_\_  
The document was recorded in the Patent and Trademark Office at  
Reel \_\_\_\_\_, Frame \_\_\_\_\_, or for which a copy thereof is attached.

3. From: \_\_\_\_\_ To: \_\_\_\_\_  
The document was recorded in the Patent and Trademark Office at  
Reel \_\_\_\_\_, Frame \_\_\_\_\_, or for which a copy thereof is attached.

☐ Additional documents in the chain of title are listed on a supplemental sheet.

☒ Copies of assignments or other documents in the chain of title are attached.

**(NOTE:** A separate copy (i.e., the original assignment document or a true copy of the original document) must be submitted to Assignment Division in accordance with 37 CFR Part 3, if the assignment is to be recorded in the records of the PTO. See MPEP 302-302.8]

The undersigned (whose title is supplied below) is empowered to sign this statement on behalf of the assignee.

7/28/00  
Date

Ted Bruce  
Signature

TED BRUCE

Typed or printed name

PRESIDENT

Title

12-12-1997

5441/PD-6023

MLO 11-17-97



100588696

To the Honorable Commissioner of Patents

with original documents or copy thereof.

1. Name of conveying party(ies):

Aaron Uri Levy  
John Patrick Sprint  
John Arthur Forthun  
Harlan Ruben Isaak  
Joel Andrew Mearig  
Mark Chandler Calkins

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

DENSE-PAC MICROSYSTEMS, INC.  
7321 Lincoln Way  
Garden Grove, California 92641-1428

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other \_\_\_\_\_

Execution Date: November 7, 1997

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: November 7, 1997

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

John P. Scherlachner  
LOEB & LOEB LLP  
10100 Santa Monica Boulevard, Suite 2200  
LOS ANGELES, CALIFORNIA 90067

6. Total number of applications and patents involved: [ 1 ]

7. Total fee (37 CFR 3.41).....\$ 40

- ☒ Enclosed  
☐ Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

12/09/1997 VIRGIN 00000066 00971499  
01 FC:581 40.00 CP

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing is true and correct and any attached copy is a true copy of the original document.

John P. Scherlachner  
ATTORNEY'S NAME

John P. Scherlachner  
ATTORNEY'S SIGNATURE

Nov. 14, 1997  
DATE

Total number of pages comprising cover sheet: [ 1 ]

# ASSIGNMENT

Attorney Docket No. 5441/PD-6023

Insert Name(s) of Inventor(s):	Aaron Uri Levy	Harlan Ruben Isaak
	John Patrick Sprint	Joel Andrew Mearig
	John Arthur Forthun	Mark Chandler Calkins

Insert name of Assignee:	DENSE-PAC MICROSYSTEMS, INC.
Insert state of incorporation of Assignee:	California
Insert address of Assignee:	7321 Lincoln Way, Garden Grove, California 92641-1428
Insert identification of invention, such as Title, Case Number or Foreign App. Number:	METHOD OF MAKING CHIP STACKS
Insert Date of Signing of Declaration:	Nov. 7, 1997

In consideration of the sum of one dollar (\$1.00) and other good and valuable considerations paid to each of the above-named, undersigned inventor(s), said undersigned agree(s) to assign, and hereby do(es) assign, transfer and set over to the above-identified Assignee, its successors and assigns, the entire and exclusive worldwide right, title and interest in and to the above-identified invention and application, any Letters Patent which may be granted and issued on said application, any continuations, divisions, reissues and extensions of said application or Letters Patent and all international priority rights associated with the above-identified invention and application. Further:

- (1) The undersigned agree(s) to execute all papers necessary in connection with any original, reissue, divisional and continuing United States and foreign applications for the above-identified invention and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.
- (2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning the above-identified application or continuation, division or reissue thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.
- (3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the international Convention for Protection of Industrial Property or similar agreements.
- (4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.
- (5) The undersigned hereby authorize(s) and request(s) the Commissioner of Patents to issue any and all Letters Patents of the United States resulting from said application or any division or divisions or continuing applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.
- (6) The undersigned hereby grant(s) STUART LUBITZ, Reg. No. 20,680; JAY M. FINKELSTEIN, Reg. No. 21,082; GARY D. MANN, Reg. No. 34,867; DON F. LIVORNESE, Reg. No. 32,040; LOUIS A. MOK, Reg. No. 22,585; JOHN P. SCHERLACHER, Reg. No. 23,009; 32,933; JONATHAN Y. KANG, Reg. No. 38,199; DAVID L. LUBITZ, Reg. No. 38,229; WEINING YANG, Reg. No. 38,690; R. DABNEY EASTHAM, Reg. No. 31,247; and HIDEO KODA, Reg. No. 27,729 the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent & Trademark Office for recordation of this document.

Date: 11-7-97	Signature of Inventor: Aaron Uri Levy
Date: 11-7-97	Signature of Inventor: John Patrick Sprint
Date: 11-7-97	Signature of Inventor: John Arthur Forthun
Date: 11-7-97	Signature of Inventor: Harlan Ruben Isaak
Date: 1-7-97	Signature of Inventor: Joel Andrew Mearig
Date: 11-7-97	Signature of Inventor: Mark Chandler Calkins